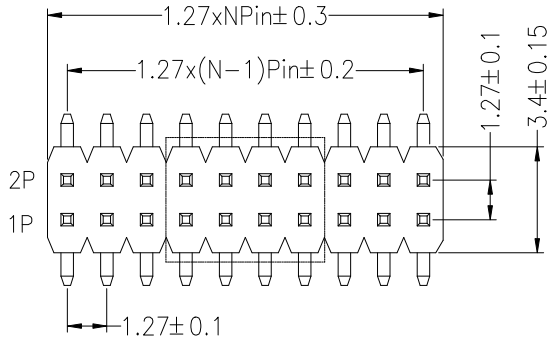
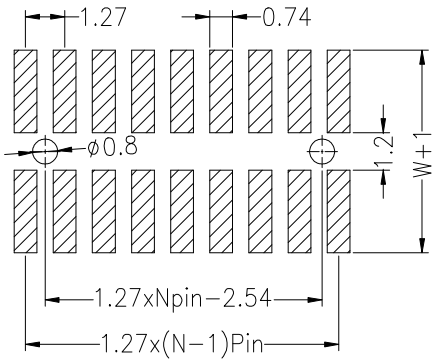
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



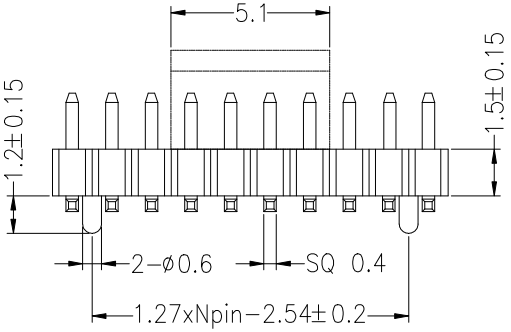

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

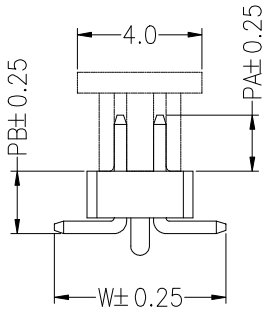



## *Ordering Information*

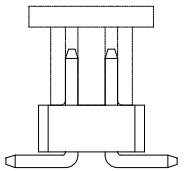
**1415 1 2 XX X X XX M XXX X 0X**

- No.of Pins Per Row: 2−50
- Insulator Material Option: C=BK−PA6T; E=BK−PA9T; F=BK−LCP
- Post: W=With Post; N=W/O Post
- Contact Plating: G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; S0:Gold Flash/Tin; SN:Tin
- Pin Length
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap




W= With Post



N= W/O Post

| Dimension antitheses list | | | |
|---|---|---|---|
| ITEM | PA | PB | W |
| Standard | 1.80 | 2.00 | 5.50 |

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2012.04.19 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 12.04.19 | SCALE | FIT |
|---|---|---|---|---|---|---|
| X.X | ± 0.30 | | | | UNIT | mm |
| X.XX | ± 0.20 | CHECK | | | SIZE | A4 |
| X.XXX | ± 0.10 | | | | SHEET | 1/1 |
| Angle | ± 3° | APPROVE | | | PROJ. | |
| DIM | TOL | | | | | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| PART NO. | 141512XXXXXXMXXXX0X |
|---|---|
| TITLE: | 1.27PH 2xnPin H1.5 SMT 夹持盖 |